

# N-Channel 30-V (D-S) MOSFET with Sense Terminal

## PRODUCT SUMMARY

| $V_{(BR)DSS}$ (V) | $r_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A)       |
|-------------------|---------------------------|-----------------|
| 30                | 0.013 at $V_{GS} = 10$ V  | 50 <sup>a</sup> |
|                   | 0.017 at $V_{GS} = 4.5$ V | 48 <sup>a</sup> |

## FEATURES

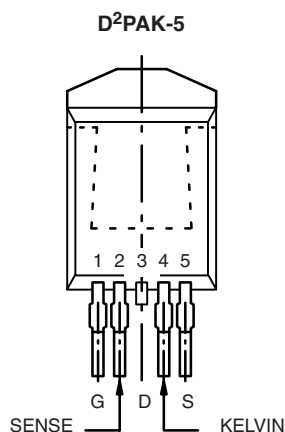
- TrenchFET® Power MOSFET Plus Current Sensing Diode
- Low Thermal Resistance Package



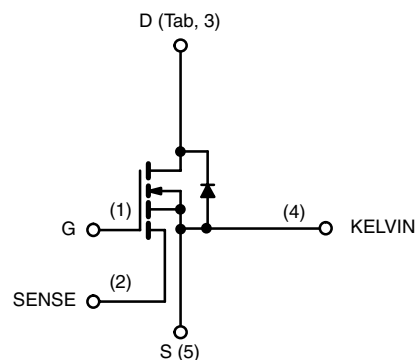
Available  
**RoHS\***  
COMPLIANT

## APPLICATIONS

- Industrial



Ordering Information: SUM50N03-13LC-E3 (Lead (Pb)-free)



N-Channel MOSFET

## ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted

| Parameter                                        | Symbol         | Limit            | Unit |
|--------------------------------------------------|----------------|------------------|------|
| Drain-Source Voltage                             | $V_{DS}$       | 30               | V    |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 20$         |      |
| Continuous Drain Current ( $T_J = 175$ °C)       | $I_D$          | 50 <sup>a</sup>  | A    |
|                                                  |                | 32 <sup>a</sup>  |      |
| Pulsed Drain Current                             | $I_{DM}$       | 100              |      |
| Avalanche Current                                | $I_{AR}$       | 25               |      |
| Repetitive Avalanche Energy <sup>b</sup>         | $E_{AR}$       | 31               | mJ   |
| Maximum Power Dissipation <sup>b</sup>           | $P_D$          | 83 <sup>c</sup>  | W    |
|                                                  |                | 2.7 <sup>d</sup> |      |
| Operating Junction and Storage Temperature Range | $T_J, T_{stg}$ | - 55 to 175      | °C   |

## THERMAL RESISTANCE RATINGS

| Parameter           | Symbol     | Limit | Unit |
|---------------------|------------|-------|------|
| Junction-to-Ambient | $R_{thJA}$ | 55    | °C/W |
| Junction-to-Case    | $R_{thJC}$ | 1.8   |      |

Notes:

- Package limited.
- Duty cycle  $\leq 1$  %.
- See SOA curve for voltage derating.
- When mounted on 1" square PCB (FR-4 material).

\* Pb containing terminations are not RoHS compliant, exemptions may apply.

| MOSFET SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted              |               |                                                                                                                            |      |       |           |               |
|------------------------------------------------------------------------------------------------|---------------|----------------------------------------------------------------------------------------------------------------------------|------|-------|-----------|---------------|
| Parameter                                                                                      | Symbol        | Test Conditions                                                                                                            | Min. | Typ.  | Max.      | Unit          |
| Static                                                                                         |               |                                                                                                                            |      |       |           |               |
| Drain-Source Breakdown Voltage                                                                 | $V_{(BR)DSS}$ | $V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$                                                                        | 30   |       |           | V             |
| Gate-Threshold Voltage                                                                         | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_{DS} = 250\text{ }\mu\text{A}$                                                                         | 1    |       | 3         |               |
| Gate-Body Leakage                                                                              | $I_{GSS}$     | $V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$                                                                            |      |       | $\pm 100$ | nA            |
| Zero Gate Voltage Drain Current                                                                | $I_{DSS}$     | $V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$                                                                                |      |       | 1         | $\mu\text{A}$ |
|                                                                                                |               | $V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}, T_J = 125\text{ }^{\circ}\text{C}$                                             |      |       | 50        |               |
|                                                                                                |               | $V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}, T_J = 175\text{ }^{\circ}\text{C}$                                             |      |       | 150       |               |
| On-State Drain Current <sup>a</sup>                                                            | $I_{D(on)}$   | $V_{DS} = 5\text{ V}, V_{GS} = 10\text{ V}$                                                                                | 50   |       |           | A             |
| Drain-Source On-State Resistance <sup>a</sup>                                                  | $r_{DS(on)}$  | $V_{GS} = 10\text{ V}, I_D = 25\text{ A}$                                                                                  |      | 0.010 | 0.013     | $\Omega$      |
|                                                                                                |               | $V_{GS} = 10\text{ V}, I_D = 25\text{ A}, T_J = 125\text{ }^{\circ}\text{C}$                                               |      | 0.016 | 0.021     |               |
|                                                                                                |               | $V_{GS} = 10\text{ V}, I_D = 25\text{ A}, T_J = 175\text{ }^{\circ}\text{C}$                                               |      | 0.018 | 0.024     |               |
|                                                                                                |               | $V_{GS} = 4.5\text{ V}, I_D = 24\text{ A}$                                                                                 |      | 0.014 | 0.017     |               |
| Forward Transconductance <sup>a</sup>                                                          | $g_{fs}$      | $V_{DS} = 15\text{ V}, I_D = 25\text{ A}$                                                                                  | 30   |       |           | S             |
| Dynamic <sup>b</sup>                                                                           |               |                                                                                                                            |      |       |           |               |
| Input Capacitance                                                                              | $C_{iss}$     | $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$                                                              |      | 1960  |           | pF            |
| Output Capacitance                                                                             | $C_{oss}$     |                                                                                                                            |      | 380   |           |               |
| Reverse Transfer Capacitance                                                                   | $C_{rss}$     |                                                                                                                            |      | 180   |           |               |
| Total Gate Charge <sup>c</sup>                                                                 | $Q_g$         | $V_{DS} = 15\text{ V}, V_{GS} = 20\text{ V}, I_D = 50\text{ A}$                                                            |      | 35    | 50        | nC            |
| Gate-Source Charge <sup>c</sup>                                                                | $Q_{gs}$      |                                                                                                                            |      | 7.6   |           |               |
| Gate-Drain Charge <sup>c</sup>                                                                 | $Q_{gd}$      |                                                                                                                            |      | 5.6   |           |               |
| Turn-On Delay Time <sup>c</sup>                                                                | $t_{d(on)}$   | $V_{DD} = 15\text{ V}, R_L = 0.3\text{ }\Omega$<br>$I_D \cong 50\text{ A}, V_{GEN} = 10\text{ V}, R_G = 2.5\text{ }\Omega$ |      | 10    | 20        | ns            |
| Rise Time <sup>c</sup>                                                                         | $t_r$         |                                                                                                                            |      | 93    | 180       |               |
| Turn-Off Delay Time <sup>c</sup>                                                               | $t_{d(off)}$  |                                                                                                                            |      | 30    | 60        |               |
| Fall Time <sup>c</sup>                                                                         | $t_f$         |                                                                                                                            |      | 10    | 20        |               |
| Source-Drain Diode Ratings and Characteristics $T_C = 25\text{ }^{\circ}\text{C}$ <sup>b</sup> |               |                                                                                                                            |      |       |           |               |
| Continuous Current                                                                             | $I_S$         |                                                                                                                            |      |       | 50        | A             |
| Pulsed Current                                                                                 | $I_{SM}$      |                                                                                                                            |      |       | 100       |               |
| Forward Voltage <sup>a</sup>                                                                   | $V_{SD}$      | $I_F = 50\text{ A}, V_{GS} = 0\text{ V}$                                                                                   |      | 1.3   | 1.6       | V             |
| Reverse Recovery Time                                                                          | $t_{rr}$      | $I_F = 50\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$                                                                      |      | 35    | 70        | ns            |
| Peak Reverse Recovery Current                                                                  | $I_{RM(REC)}$ |                                                                                                                            |      | 1.5   |           | A             |
| Reverse Recovery Charge                                                                        | $Q_{rr}$      |                                                                                                                            |      | 0.026 |           | $\mu\text{C}$ |
| Current Sense Characteristics                                                                  |               |                                                                                                                            |      |       |           |               |
| Current Sensing Ratio                                                                          | r             | $I_D = 1\text{ A}, V_{GSS} = 10\text{ V}, R_{SENSE} = 1.1\text{ }\Omega$                                                   | 420  | 520   | 620       |               |
| Mirror Active Resistance                                                                       | $r_{m(on)}$   | $V_{GS} = 10\text{ V}, I_D = 10\text{ mA}$                                                                                 |      | 3.5   |           | $\Omega$      |

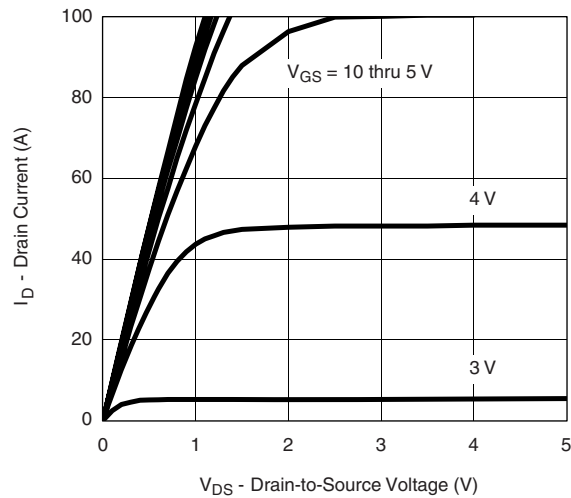
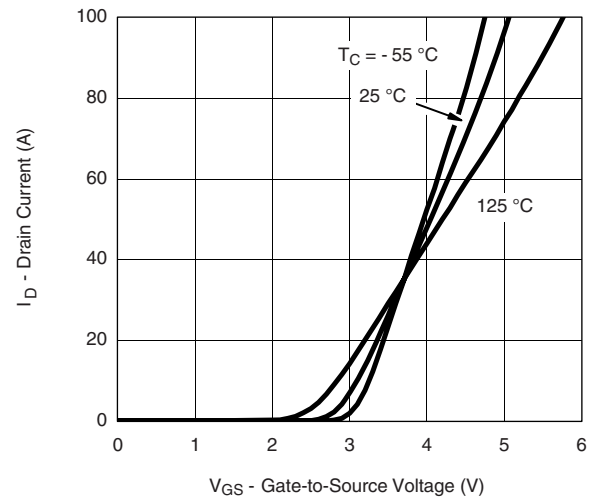
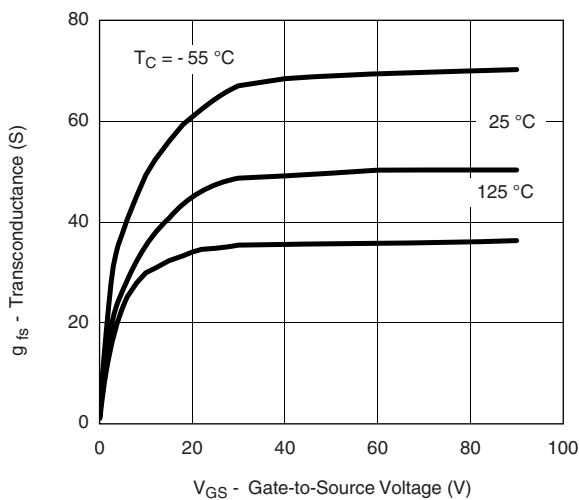
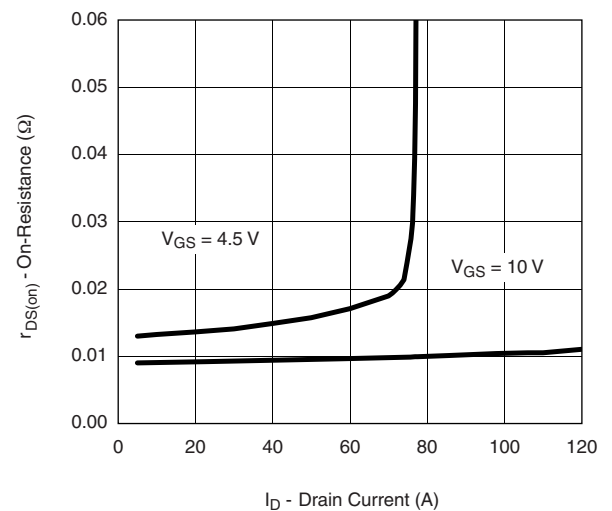
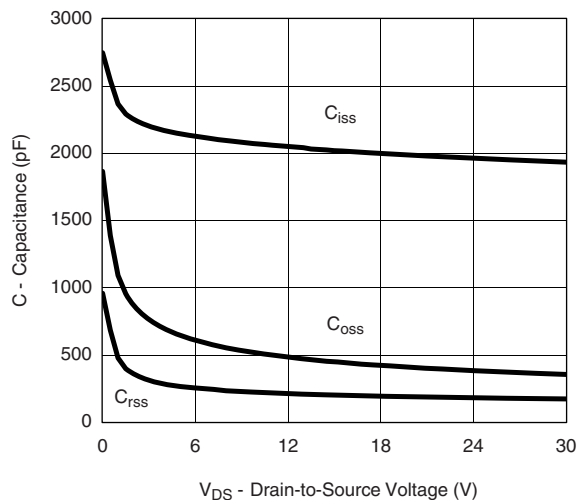
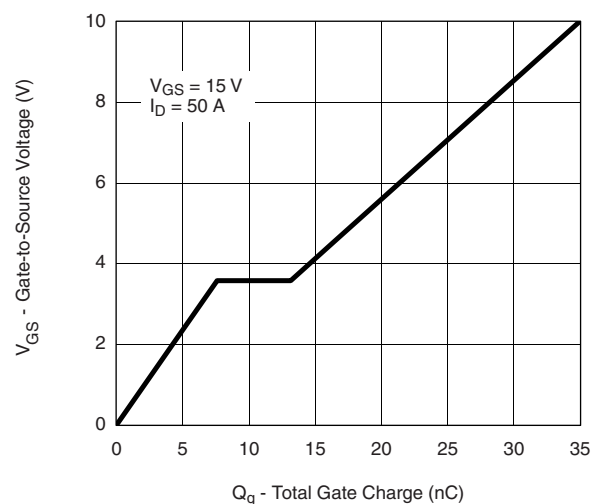
Notes:

a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

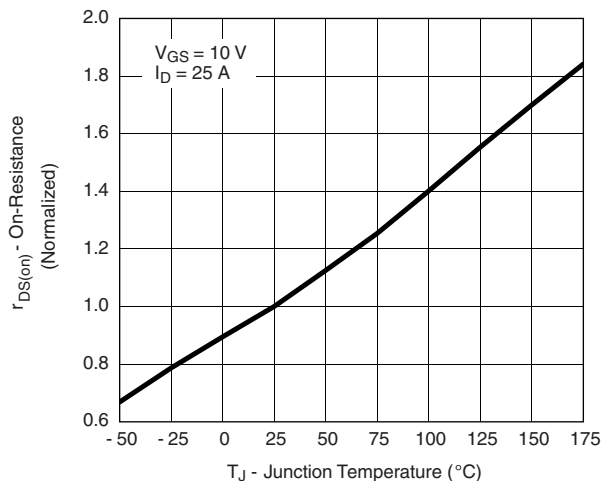
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

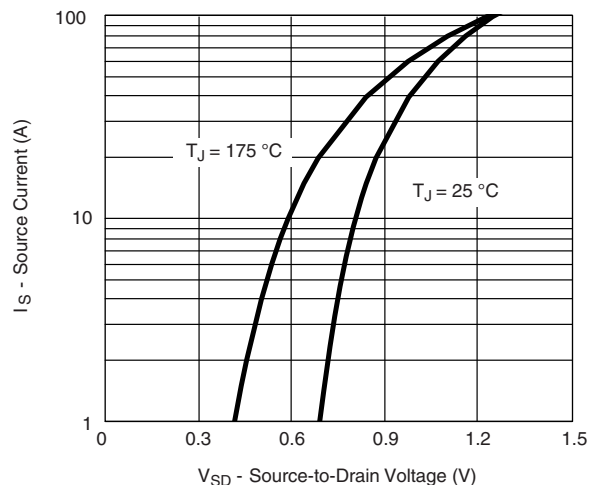
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted**Output Characteristics****Transfer Characteristics****Transconductance****On-Resistance vs. Drain Current****Capacitance****Gate Charge**

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

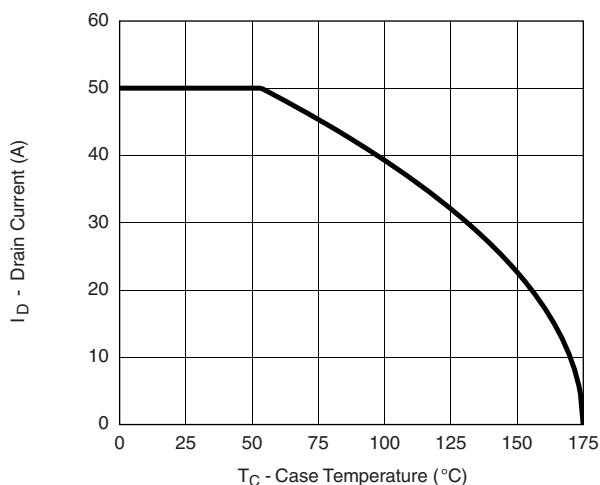


On-Resistance vs. Junction Temperature

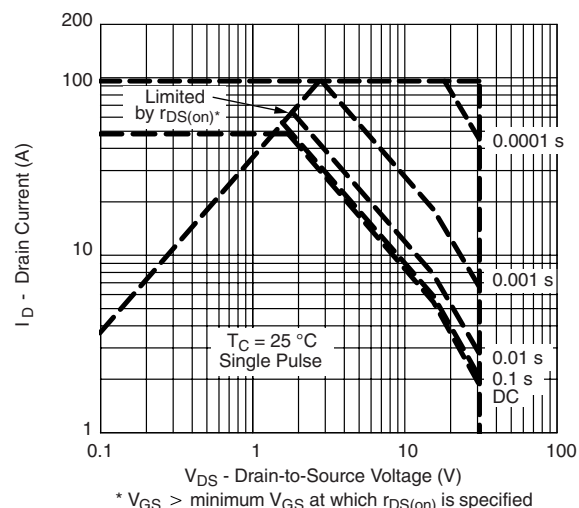


Source-Drain Diode Forward Voltage

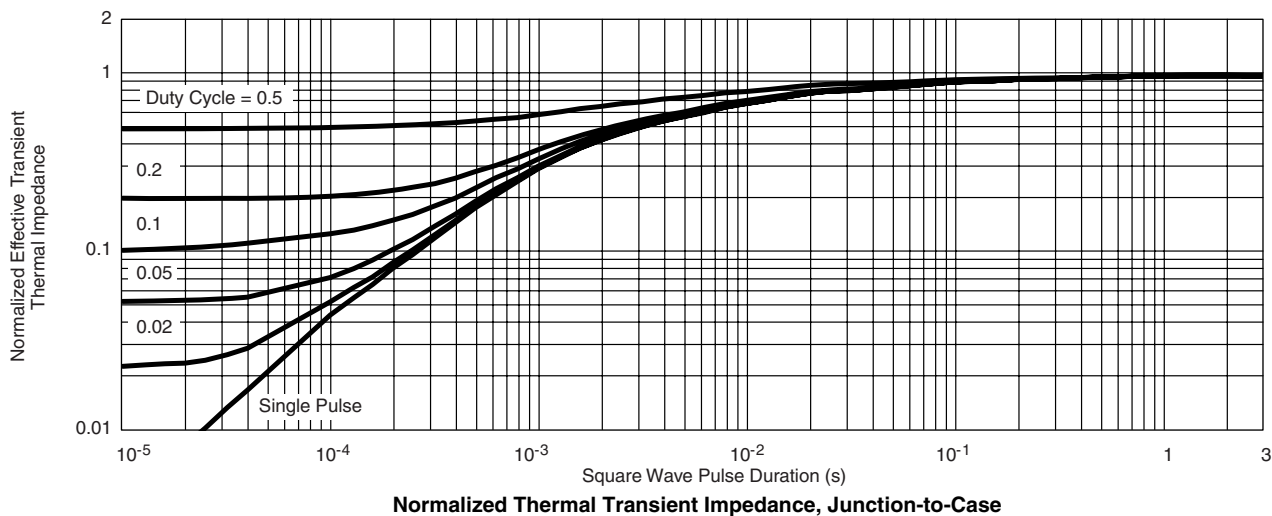
## THERMAL RATINGS



Maximum Drain Current vs. Case Temperature

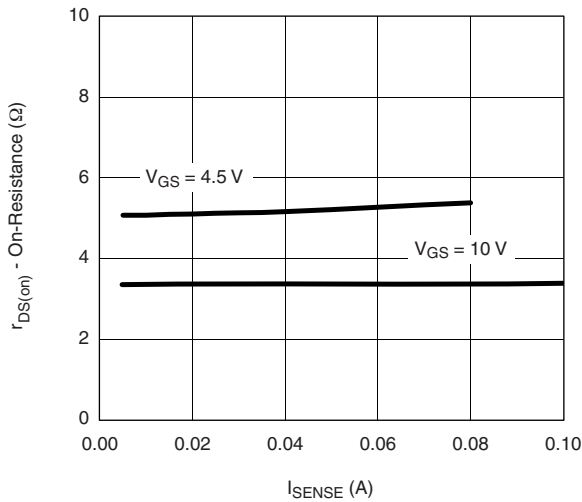


Safe Operating Area

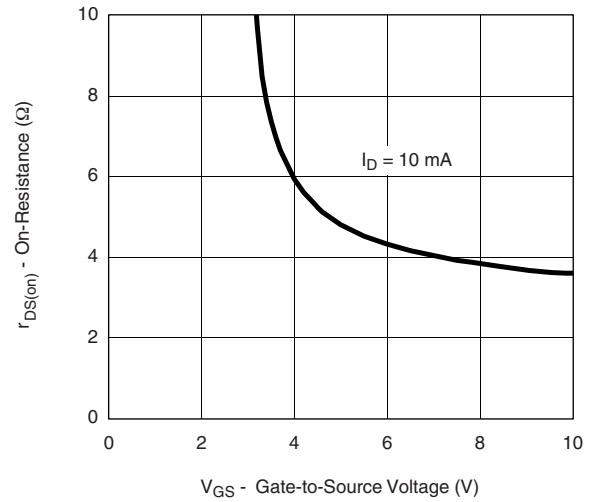


Normalized Thermal Transient Impedance, Junction-to-Case

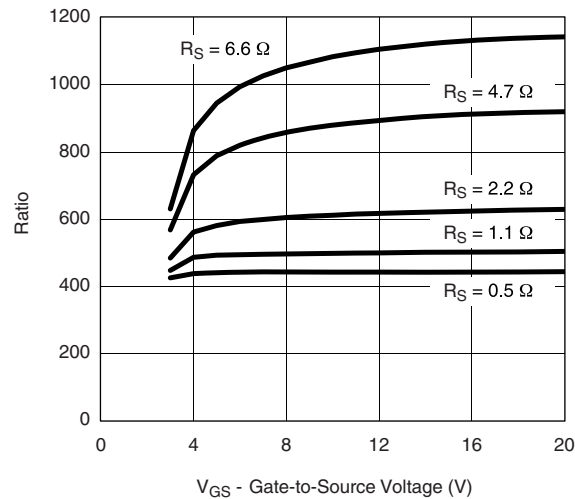
## SENSE DIE TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Sense Current



On-Resistance vs. Gate-Source Voltage



Current Ratio ( $I_{MAIN}/I_S$ ) vs. Gate-Source Voltage (Figure 1)

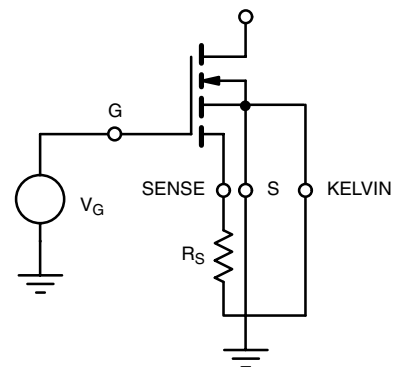


Figure 1.

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